



\*\*Note: Forced air at 150LFPM will reduce thermal resistance to  $0.37^{\circ}\text{C/W}$ . Forced air at 500LFPM will reduce thermal resistance to  $0.2^{\circ}\text{C/W}$ .

**P1 HEATSINK**  
 MAT'L: 6063-T5 ALUMINUM (AAVID EXTRUSION #69800)  
 FINISH: ANODIZE PER MIL-A-8625, TYPE II, CL 2, BLACK  
 TYPICAL BREAKDOWN VOLTAGE > 300V

- NOTES:**
1. Unless otherwise noted, all dimensions are in inches.
  2. Break all sharp edges, de-burr & remove loose chips.
  3. Mark with contrasting ink as shown, if specified by purchase order.
  4. Thermal rating:  $0.5^{\circ}\text{C/W}$  \*\*

TOLERANCES - UNLESS OTHERWISE SPECIFIED		TITLE		MODEL	
JXX = ±0.01 [254]		MODULAR PACKAGE HEATSINK		HS26	
JXX = ±0.005 [127]		MECHANICAL DRAWING		REV: E	
ANG. = ±5°		ENGINEER: AOL	DRAWN BY: J.FAY	DWG: 14040	BL: 1
		DATE: 24MAR14			

# Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

[Apex Microtechnology:](#)

[HS26](#)